LASERSCOM
Coupling Light to Your Success

LDS-1470-DFB-2.5G-15/45

OVERVIEW

LDS-1470-DFB-2.5G-15/45 is the MQW laser diode coupled to an optical fiber and packaged into a hermetic case. The special feature of the LDS technology is the increased thermal stability of optical power

MAIN FEATURES

- Wavelength: 1470 nm
- Cavity type: DFB
- Linewidth: <500 kHz
- Data rate up to 2.5 Gbps
- Optical power: up to 15 mW in CW mode, up to 45 mW in SM fiber G.657.A1
- Package types: coaxial, coaxial with bracket
- Built-in monitor photodiode

APPLICATIONS

- Optical fiber communication systems with data rate up to 2.5 Gbps
- Laser systems

ORDERING INFORMATION

LDS-1470-DFB-2.5G-15/45-X-2-X-X-X-X

Case type

U: compact coaxial (pulse mode only)
B: compact coaxial with double-sided bracket
Other type on request

Fiber type

SM1: SM, G.657.A1, Corning SMF-28 Ultra, furcation tubing ∅0.9 mm or **BSM1** ∅0.25mm
SM3: SM, G.657.B3, Corning ClearCurve ZBL, furcation tubing ∅0.9 mm or **BSM3** ∅0.25mm
SMP13: PM, Fujikura SM13, PANDA type, furcation tubing ∅0.9 mm
Other type on request

Connector type

FA: FC/APC (SM1, SM3, SMP13)
FU: FC/UPC (SM1, SM3)
SA: SC/APC (SM1)
SU: SC/UPC (SM1)
N: no connector
Other type: on request

Test measurements

CW: CW mode (electro-optical parameters at T=25+/-5 C and spectrum)
P: pulse mode (10 µs; duty cycle = 1%)
CWP: both CW and pulse modes

Fiber length

0.5: 500+/-50 mm
1.0: 1000+/-100 mm
Other length on request

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ABSOLUTE MAXIMUM RATINGS

Parameter		Value	Unit	Conditions
Laser diode forward current	I_{FL}	120	mA	CW
		450	mA	Pulse
Laser diode reverse voltage	V_{RL}	2	V	
Photodiode reverse voltage	V_{RP}	20	V	
Photodiode forward current	I_{Fp}	2	mA	
Operating temperature	T_{OP}	-40 - +85	°C	Package U, B
Storage temperature	T_{stg}	-50 - +85	°C	
Soldering temperature	T_{sold}	260	°C	Max. 10 seconds

ELECTRICAL-OPTICAL CHARACTERISTICS (T = 25 °C)

Parameter		MIN	TYP	MAX	Unit	Conditions
Optical power (CW)	P_{CW}	15			mW	CW, I_{op} = 120 mA, SM1
Optical power (pulse)	P_P	40	45		mW	Pulse, I_{op} = 450 mA
Wavelength	λ	1467	1470	1473	nm	CW, I_{op} = 120 mA
Spectral width	$\Delta\lambda$		0.09		nm	CW, I_{op} = 120 mA, -20 dB, OSA
Spectral width	Δf			500	kHz	CW, I_{op} = 120 mA, delayed self-heterodyne method
Wavelength-temperature coeff.	dλ/dT		0.13		nm/°C	
Side-mode suppression ratio	SMSR	40	55		dB	CW, I_{op} = 120 mA
Threshold current	I_{th}		8	12	mA	CW
Slope efficiency	S_e	0.13	0.16		W/A	CW, SM1
Operating voltage	V_{op}		1.4	1.8	V	CW, I_{op} = 120 mA
Tracking error	E_r		0.15	0.30	dB	CW, P = 3 mW; T = -40 ÷ +80 °C
Rise and fall times	t_r, t_f		80	120	ps	20%-80%, package U, B
Resonance frequency	f_r		6.0		GHz	2.5Gbps, Imod = 40mA, Ibias = Ith+2 mA
Monitoring output current (PD)	I_m	1.0	1.7	5.0	mA	CW, I_{op} = 120 mA, V_{rd} = 5V
Capacitance (PD)	C_t		10	20	pF	V_{rd} = 5V, f = 1 MHz
Dark current (PD)	I_d			100	nA	V_{rd} = 5V
Polarization extinction ratio	PER	20			dB	CW, SMP13

Pulse mode: pulse duration 10 μs; duty cycle = 1%

Tracking error E_r = max |10 lg [P(T)/P(25°C)]|, I_m= const, T = T_{min} ÷ T_{max}

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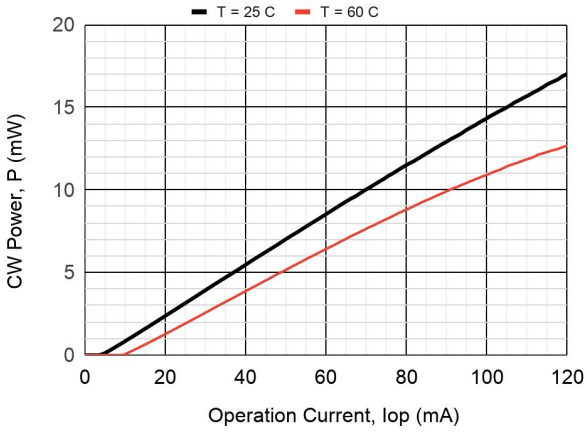

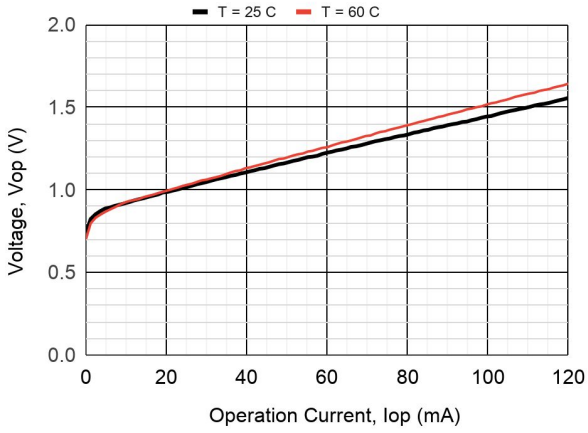

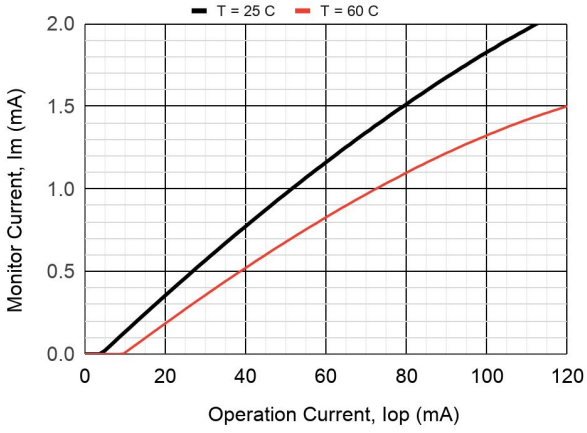

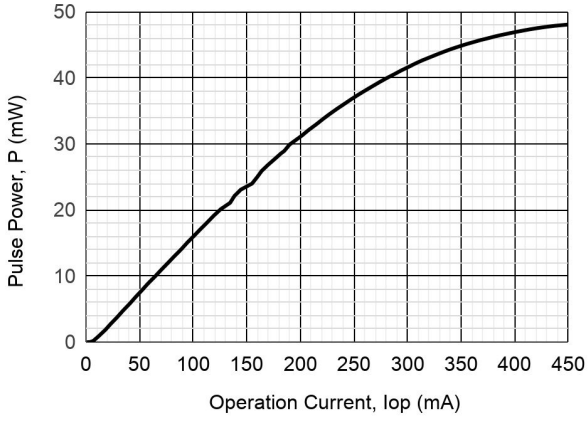

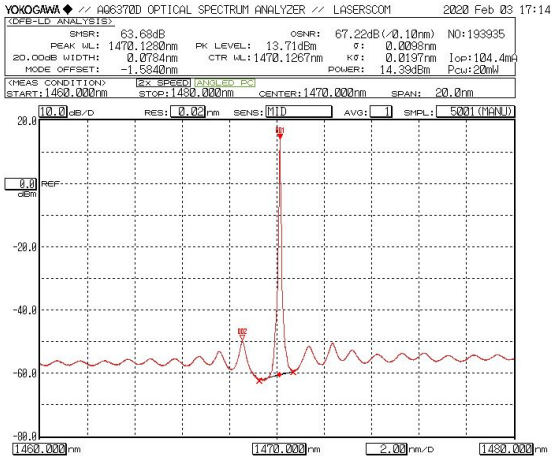

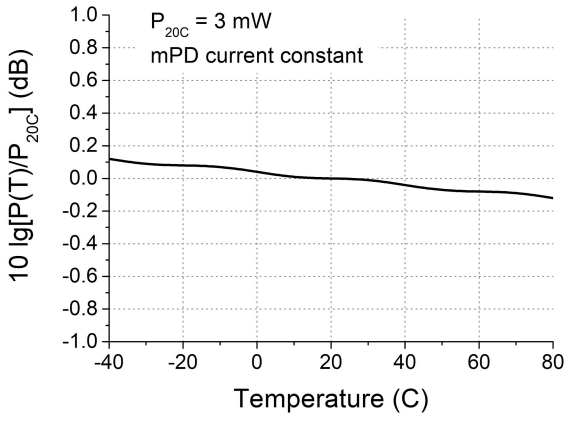

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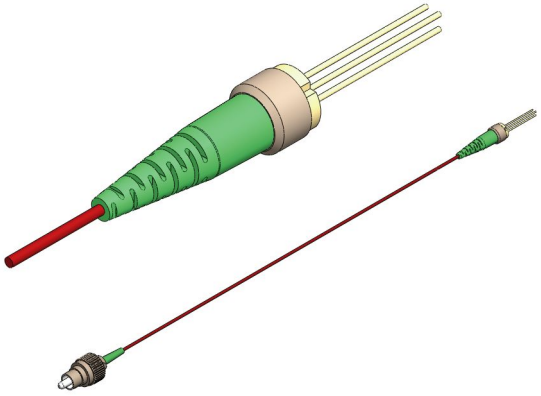
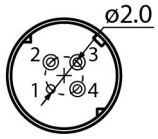


PACKAGE U

BACK VIEW



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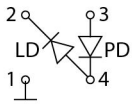
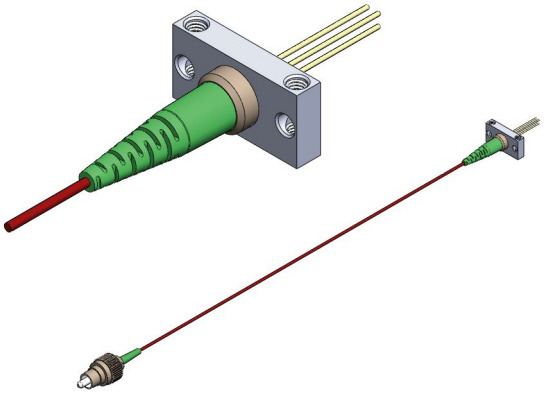


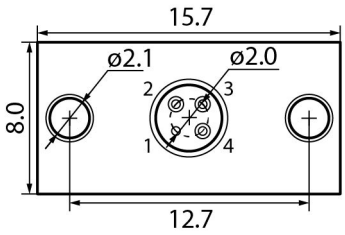
Download more information

Drawing | 3D model | Application Notes



PACKAGE B

BACK VIEW



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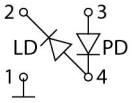

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Characteristics, data, materials and structures specified in this datasheet are subject to change without notice. Please refer to the latest specification before use of the products.

Safety and handling cautions

1. Avoid smashing and burning of the module. Avoid storing and using the module in conditions where water, organic solvents or aggressive acids or bases may contact the module or where there is a possibility of exposure to corrosive gases, explosive gases, dust, salinity or other harsh conditions. The module should be disposed as special industrial waste.
2. Exceeding absolute maximum ratings even for a short time can cause permanent damage of the module.
3. The module is sensitive to and can be broken by ESD (static electricity).

Conflict Minerals Policy Statement

LasersCom LLC achieves business objectives and customer needs with social responsibility. We do not support or contribute to the violence and human rights violations associated with the mining of conflict minerals coming from Conflict Regions according to US "Dodd-Frank Act". When possible, our suppliers' conflict mineral statements are reviewed. We do not directly purchase Conflict Minerals from any source and do not knowingly procure any parts and products containing Conflict Minerals from Conflict Regions.

RoHS Compliance Statement

Restriction of Hazardous Substances (RoHS) directive (Directive 2011/65/EC amended with Directive (EU) 2015/863) is the directive aimed at reducing the harmful environmental impact of waste electrical equipment by restricting the use of known dangerous substances. Based on information received from our supply sources, LasersCom LLC hereby states that the banned substances listed in the RoHS directive are not found in the parts and materials used above the threshold level listed other than exceptions approved by the European Commission.

REACH Compliance Statement

Registration, Evaluation, Authorisation and Restriction of Chemicals (REACH) is a European Union regulation 1907/2006/EC that addresses the production and use of chemical substances, and their potential impacts on human health and the environment. Based on information received from our supply sources, LasersCom LLC hereby states compliance of the parts and materials used in manufacturing to REACH regulation. LasersCom LLC does not manufacture or import any substances or preparations as defined under REACH.